

### AMPMODU | AMPMODU Headers

TE Internal #: 102802-4 PCB Mount Header, Right Angle, Board-to-Board, 50 Position, .1 in [2.54 mm] Centerline, Partially Shrouded, Gold, AMPMODU Headers

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### PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Right Angle

Connector System: Board-to-Board

Number of Positions: **50** 

Number of Rows: 2

### Features

### Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Partially Shrouded



Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
PCB Mount Orientation	Right Angle
Number of Positions	50
Number of Rows	2
Board-to-Board Configuration	Co-Planar
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	750 VACrms
Operating Voltage	250 VAC
Body Features	
Primary Product Color	Black
Contact Features	
Contact Layout	Inline
Contact Mating Area Length	8.07 mm[.318 in]
Mating Square Post Dimension	.64 mm[.025 in]

**C** For support call+1 800 522 6752

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	100 – 200 µin
PCB Contact Termination Area Plating Material Finish	Bright
Contact Shape & Form	Square
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Pin
Contact Current Rating (Max)	2 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.18 mm[.125 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Retention	Without
PCB Mount Retention Type	Board Retention Tail
Mating Alignment	With
Mating Alignment Type	Guide Pins

Mating Alignment Type	Guide Pins
PCB Mount Retention	With
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Thermoplastic
Dimensions	
Connector Height	8.13 mm[.32 in]
Row-to-Row Spacing	2.54 mm[.1 in]
PCB Thickness (Recommended)	1.4 mm[.055 in]
Usage Conditions	
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Operation/Application	
Assembly Process Feature	None

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Circuit Application	Signal
ndustry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	7
Packaging Type	Tube
•	
Product Compliance	
For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	Not Compliant
or compliance documentation, visit the product page on TE.com>	Not Compliant Not Compliant
For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	

Halogen Content

Solder Process Capability

BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.

Wave solder capable to 240°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**

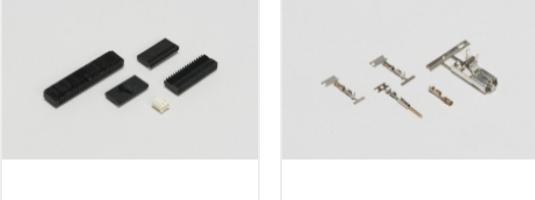
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# Also in the Series AMPMODU Headers





Wire-to-Board Connector Assemblies	Wire-to-Board Connector Contacts(66)
& Housings(5)	

## Customers Also Bought





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## Documents

Product Drawings 50 MODII 2PC HDR DRRA SHRD

English

### **CAD** Files

Customer View Model ENG\_CVM\_CVM\_102802-4\_N.2d\_dxf.zip

English

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_102802-4\_N.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_102802-4\_N.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Environmental Compliance TE Material Declaration

English